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HIGH PRECISION COMPUTED TOMOGRAPHY FOR METROLOGY

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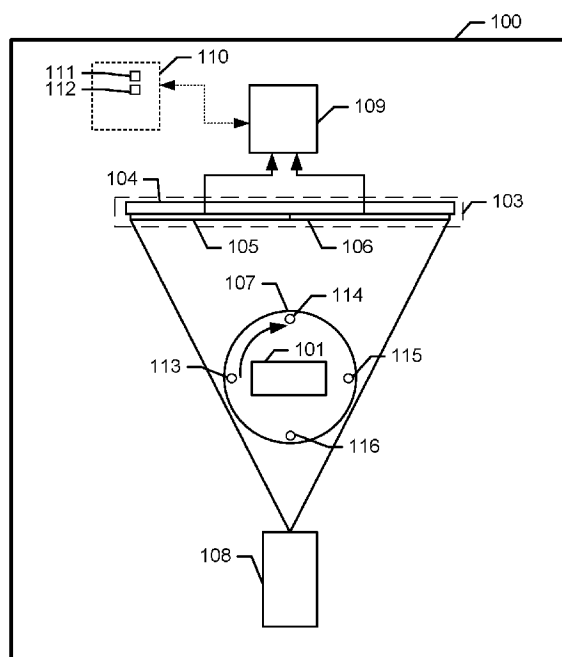


Fig. 1

(57) **Abstract:** Disclosed is a CT system for performing measurements on an object. The CT system comprises a support element for supporting the object; a radiation source for radiating the object at a plurality of different angles; a radiation detector assembly for detecting radiation passed through the object and in response thereto generate radiation data; and a processing unit operatively connected to the radiation detector assembly. The radiation detector assembly comprises a support, a first detector array, and a second detector array, the first detector array and the second detector array being attached to the support. The processing is configured to generate tomographic images of the object by processing radiation data received from the radiation detector assembly together with first calibration data describing properties of the first detector array and second calibration data describing properties of the second detector array.



Title High precision Computed Tomography for metrology

Field

- 5 The present invention relates to a Computed tomography system for performing measurements on an object and to a method of using such a system.

Background

10

Measurements of the spatial (x, y, z) position of a plurality of internal and/or external points of objects is a central task in the production industry. The measurements are performed to secure that the machines, tools, and finished products are all within the required level of tolerance. Precision and speed are two of the most important characteristics of a measuring system.

15

Computed tomography (CT) has become an important tool for measuring objects. The objects are radiated with x-rays from an x-ray source at a plurality of angles, and the attenuated radiation that has passed through the object is measured using an X-ray detector array. The output from the X-ray detector array is processed by a processing unit to create 3D tomographic images used for the measurements. CT is a fast technique but for an object of a fixed size the spatial resolution is bound by the number of pixels in the X-ray detector array. Making large X-ray detector arrays is however difficult and expensive.

25

US5119408 discloses a method for inspecting a component having dimensions larger than a fan beam angle of an x-ray inspection system. The method includes the steps of: providing an x-ray beam having a selected fan angle in a source focal point; positioning a portion of the component

30 substantially completely within the x-ray beam; rotating the component 360

degrees around a component inspection rotational axis; collecting the attenuated x-ray beam that passes through the component during rotation; generating a multiplicity of electrical signals responsive to the collected x-ray beam; incrementally moving the component inspection rotational axis about the x-ray source focal point to position another portion of the component within the x-ray beam; and repeating the steps of rotating the part 360 degrees about a component inspection rotational axis and incrementally moving the part inspection rotational axis about the x-ray source focal point until the entire component has passed through the fan beam.

10

It is however a problem with the above mentioned method that the total time required to perform a 3D measurement of the entire object is significantly increased as a full 360 degrees CT scan needs to be performed each time the part is moved.

15

Thus, it remains a problem to provide a method / system for performing spatial (x,y,z) measurements on an object, which simultaneously is fast and exhibits a high spatial accuracy.

20 **Summary**

According to a first aspect, the invention relates to a CT system for performing spatial measurements on an object comprising:

- a support element for supporting the object;
- a radiation source for radiating the object at a plurality of different angles;
- a radiation detector assembly for detecting radiation passed through the object and in response thereto generate radiation data; and
- a processing unit operatively connected to the radiation detector assembly;

30

wherein the radiation detector assembly comprises a support, a first detector array comprising a plurality of detector elements attached to a support, and a second detector array comprising a plurality of detector element attached to a support, the support of the first detector array being attached to the support
5 of the radiation detector assembly, the support of the second detector array being attached to the support of the radiation detector assembly ; and said processing unit being configured to generate tomographic images of the object by processing radiation data received from the radiation detector assembly together with first calibration data describing properties of the first
10 detector array and second calibration data describing properties of the second detector array.

Consequently, by using a radiation detector assembly comprising a plurality of individual detector arrays a fast high precision CT system for performing spatial measurements is provided. The use of a plurality of detector arrays
15 enables “large” objects to be scanned without translating the objects after a 360 degrees scan or changing the scan geometry by increasing the distance between the radiation source and the radiation detectors. Translation of the objects would results in a significant increase in the scan time as explained previously and changing the scan geometry would result in a decreases
20 spatial resolution as each pixel in the radiation detector would cover a larger part of the object. Furthermore, by using first and second calibration data misalignments between the individual detector arrays may be compensated for.

25 The CT system may comprise a movable radiation source and radiation detector assembly, i.e. the radiation source and the radiation detector assembly may be configured to revolve around the support element, whereby the object may be radiated at a plurality of angles. Alternatively, the support element may be configured to rotate the object around a central axis whereby
30 the object may be radiated at a plurality of angles. The radiation source is preferably an X-ray radiation source. Correspondingly, the detector arrays

are preferably X-ray detector arrays. The detector arrays may have a rectangular shape comprising MXN pixels or as a special case have a square shape and comprise NxN pixels, e.g. the detector arrays may comprise 2024x2024 pixels or 4048x4048 pixels. The detector arrays may be attached to the support in any manner e.g. the detector arrays may be adhered to the support using an adhesive or the support may have fixtures configured to grip the detector arrays. The support may be a planar support. The first detector array may abut the second detector array. Spatial measurement may be performed on the generated tomographic images e.g. by determining the position of a plurality of internal and/or external points of the object in the tomographic images.

The radiation detector assembly may comprise more than two detector arrays. The radiation detector assembly may comprise at least four detector arrays arranged in a 2x2 matrix and the processing unit may be configured to generate tomographic images of the object by processing radiation data received from the radiation detector assembly together with calibration data for each of the four detector arrays. The radiation detector assembly may comprise at least nine detector arrays arranged in a 3x3 matrix and the processing unit may be configured to generate tomographic images of the object by processing radiation data received from the radiation detector assembly together with calibration data for each of the four detector arrays.

The radiation detector assembly may comprise at least sixteen detector arrays arranged in a 4x4 matrix and the processing unit may be configured to generate tomographic images of the object by processing radiation data received from the radiation detector assembly together with calibration data for each of the sixteen detector arrays. The radiation detector assembly may comprise in total at least 5000, 7000, or 10 000 pixels along a first axis. The radiation detector assembly may comprise in total at least 5000, 7000, or 10000 pixels along a first axis, and at least 5000, 7000, or 10000 pixels along a second axis, wherein the second axis is perpendicular to the first axis. The

system may further comprise a memory unit, wherein the first calibration data and the second calibration data are stored on the memory unit. The processing unit may generate the tomographic images using any reconstruction algorithm such as the filtered back projection algorithm or derivatives of this, algebraic reconstructions algorithms such as ART, SART, and SIRT, discrete tomography algorithms, optimization algorithms, and algorithms using iterative physical model-based maximum likelihood expectation maximization techniques. A priori knowledge of the shape of the object may be used in the reconstruction.

10

In some embodiments, the first detector array is arranged immediately next to the second detector array, the plurality of detector elements of the first detector array and /or the second detector array are arranged with a pitch P, and wherein the smallest distance from the centre of any detector element of the first detector array to the centre of any detector element of the second detector array is at least 2 times larger than the pitch P, 5 times larger than the pitch P, or 10 times larger than the pitch P.

The pitch P of a first array and / or the second array is defined as the distance from the centre of a first detector element in the array to the centre of a neighbouring detector element. The pitch P for the first detector array and / or the second detector array may be in the range 30 μ m to 300 μ m, more preferably in the range 50 μ m to 200 μ m

In some embodiments, the first detector array is arranged immediately next to the second detector array, and the smallest distance from the centre of any detector element of the first detector array to the centre of any detector element of the second detector array is at least 1mm, 0.5 cm, or 1cm.

In some embodiments, the first calibration data comprises data indicative of the spatial location the first detector array and the second calibration data comprises data indicative of the spatial location of the second detector array.

- 5 Consequently, the system may compensate for any spatial offset between the detector arrays.

The data indicative of the spatial location may be data specifying the spatial location of the centre of the detector arrays or the spatial location of another
10 part of the detector arrays.

In some embodiments, the first calibration data comprises data indicative of the orientation of the first detector array and the second calibration data comprises data indicative of the orientation of the second detector array.

- 15 Consequently, the system may compensate for any rotation of the detector arrays.

In some embodiments, the support element is rotatably arranged relative to
20 the radiation sources and the radiation detector assembly.

Consequently, the radiation detector assembly may be kept stationary thereby limiting any movement of the individual detector arrays.

- 25 In some embodiments, the processing unit is configured to obtain the first calibration data and the second calibration data by processing radiation data received from the radiation detector assembly originating from scanning a reference object.

- 30 The reference object may comprise one or more spatial markers and the processing unit may be configured to detect the one or more spatial markers

in the radiation data for a plurality of different angles and use that information to derive the first calibration data and the second calibration data.

In some embodiments, the support element comprises the reference object.

5

In some embodiments, the processing unit is configured to firstly generate the first calibration data and the second calibration data by processing first radiation data, and secondly generate tomographic images of the object by processing the first radiation data together with the first calibration data and the second calibration data.

10

Consequently, the calibration data may be generated simultaneously with an object is being scanned. This improves the speed of the method as there no longer is a need of a separate calibration step before an object can be analyzed. Furthermore, the precision may be improved as it can be secured that the first calibration data and the second calibration data is completely updated.

15

The system may comprise a memory unit operatively connected to the radiation detector assembly and the processing unit, wherein the memory unit is configured to store un-processed radiation data for a plurality of different angles, and wherein the processing unit is configured to receive the un-processed radiation data from the memory unit after it has generated the first calibration data and the second calibration data.

20

25

In some embodiments, the processing unit is configured to firstly generate the first calibration data and the second calibration data by processing first radiation data, and secondly generate tomographic images of the object by processing the first radiation data together with the first calibration data and the second calibration data, wherein the radiation data comprises data from a first set of different angles, the tomographic images consist of a plurality of

30

pixels each pixel in a tomographic image is reconstructed using a reconstruction algorithm that utilizes data from a particular subset of the first set of different angles to take account of the spacing between the first detector array and the second detector array, and wherein the processing unit is configured to for each pixel in the tomographic image determine the pixels particular subset from the first calibration data and the second calibration data.

The spacing between the detector arrays will result in that some angles do not contain information / data for a number of pixels in a tomographic image as that information is lost in the gap between the detector arrays. Even a small movement of the support element, the radiation source, or any one of the detector arrays may significantly influence the affected pixels.

Thus, by determining the particular subset of angles for each pixel at the same time as the object is being scanned it may be secured that the correct subset is used for each pixel. This results in a more precise reconstruction.

In some embodiments, CT system is configured to translate the object relative to the radiation source and radiation detector assembly between different angles.

Consequently, artefacts resulting from the spacing between the first detector array and the second detector array may be reduced.

The support and / or radiation source and radiation detector assembly may be translated.

In some embodiments, the object is translated at least 100 μm , 200 μm , 500 μm or 800 μm .

In some embodiments, the radiation detector assembly is obtained by the process of:

- providing the support;
- 5 • providing the first detector array:
- providing the second detector array;
- attaching the support of the first detector array to the support of the radiation detector assembly;
- 10 • attaching the support of the second detector array to the support of the radiation detector assembly.

According to a second aspect, the invention relates to a method for performing spatial measurements on an object using a CT system,
15 the CT system comprising: a support element for supporting the object; a radiation source for radiating the object; a radiation detector assembly for detecting radiation passed through the object; and a processing unit operatively connected to the radiation detector assembly,
20 wherein the radiation detector assembly comprises a support, a first detector array comprising a plurality of detector elements attached to a support, and a second detector array comprising a plurality of detector element attached to a support, the support of the first detector array being attached to the support of the radiation detector assembly, the support of the second detector array being attached to the support of the radiation detector assembly, the method
25 comprising the steps of:

- arranging the object at a plurality of angles with respect to the radiation source and the radiation detector assembly and radiating the object at each of the plurality of angles using the radiation source thereby generating radiation data using the radiation detector
30 assembly;

- generating tomographic images of the object by processing using the processing unit, the radiation data together with first calibration data describing properties of the first detector array and second calibration data describing properties of the second detector array; and
- 5
- analyzing the tomographic images to measure parts of the object.

Consequently, by using a radiation detector assembly comprising a plurality of individual detector arrays a fast high precision CT system for performing measurements is provided. Furthermore, by using first and second calibration

10 data misalignments between the individual detector arrays may be compensated for.

The tomographic images may be analyzed automatically using computational image analysis or manually by a human operator.

15

In some embodiments, the first calibration data comprises data indicative of the spatial location of the first detector array and the second calibration data comprises data indicative of the spatial location of the second detector array.

20 In some embodiments, the first calibration data comprises data indicative of the orientation of the first detector array and the second calibration data comprises data indicative of the orientation of the second detector array.

In some embodiments, the support element is rotatably arranged relative to

25 the radiation source and the radiation detector assembly and the object is arranged at the plurality of angles by rotating it using the support element.

In some embodiments, the processing unit is configured to obtain the first calibration data and the second calibration data by processing data from the

30 radiation detector assembly originating from scanning a reference object.

In some embodiments, the support element comprises the reference object.

In some embodiments, the processing unit firstly generate the first calibration data and the second calibration data by processing the radiation data, and
5 secondly generate tomographic images of the object by processing the radiation data together with the first calibration data and the second calibration data.

In some embodiments, the processing unit firstly generate the first calibration
10 data and the second calibration data by processing first radiation data, and secondly generate tomographic images of the object by processing the first radiation data together with the first calibration data and the second calibration data, wherein the radiation data comprises data from a first set of
different angles, the tomographic images consist of a plurality of pixels each
15 pixel in a tomographic image is reconstructed using a reconstruction algorithm that utilizes data from a particular subset of the first set of different angles to take account of the spacing between the first detector array and the second detector array, and wherein the processing unit it configured to for
each pixel in the tomographic image determine the pixels particular subset
20 from the first calibration data and the second calibration data.

In some embodiments, the object is translated relative to the radiation source
and radiation detector assembly between different angles.

25 .

The support and / or radiation source and radiation detector assembly may be translated.

30 In some embodiments, the object is translated at least 100 μm , 200 μm , 500 μm or 800 μm .

The different aspects of the present invention can be implemented in different
5 ways including as a CT system for performing measurements on an object,
and a method for performing measurements on a object using a CT system
described above and in the following, each yielding one or more of the
benefits and advantages described in connection with at least one of the
aspects described above, and each having one or more preferred
10 embodiments corresponding to the preferred embodiments described in
connection with at least one of the aspects described above and/or disclosed
in the dependant claims. Furthermore, it will be appreciated that
embodiments described in connection with one of the aspects described
herein may equally be applied to the other aspects. Furthermore, it will be
15 appreciated that embodiments described in connection with one of the
aspects described herein may equally be applied to the other aspects.

Brief description of the drawings

20 The above and/or additional objects, features and advantages of the present
invention, will be further elucidated by the following illustrative and non-
limiting detailed description of embodiments of the present invention, with
reference to the appended drawings, wherein:

25 Fig. 1 shows a schematic drawing of a CT system according to an
embodiment of the present invention.

Fig. 2a shows a schematic drawing of a radiation detector assembly
according to an embodiment of the present invention.

Fig. 2a shows a schematic drawing of a radiation detector assembly
30 according to an embodiment of the present invention.

Fig. 3 shows a schematic drawing of a radiation detector assembly comprising four detector arrays according to an embodiment of the present invention.

Fig. 4 shows a schematic drawing of a radiation detector assembly
5 comprising sixteen detector arrays according to an embodiment of the present invention.

Fig. 5 shows a flow chart for a method according to an embodiment of the present invention.

10

Detailed description

In the following description, reference is made to the accompanying figures,
15 which show by way of illustration how the invention may be practiced.

Fig. 1 shows a schematic drawing of a CT system 100 for performing spatial measurement on an object 101 according to an embodiment of the invention. The CT system 100 is shown from the top. The CT system 100 comprises a
20 support 107 for supporting the object 101, a radiation source 108 for radiating the object at a plurality of different angles, a radiation detector assembly 103 for detecting radiation passed through the object 101 and in response thereto generate radiation data, and a processing unit 109 operatively connected to the radiation detector assembly 103. The radiation detector assembly 103
25 comprises a support 104, a first detector array 105, and a second detector array 106. The first detector array 105 and the second detector array 106 are attached to the support 104. The support element 107 is configured to rotate the object 101 around a central axis whereby the object 101 may be radiated at a plurality of different angles, i.e. for each angle the radiation source 108
30 radiate the object 101 and the radiation detector assembly 103 measures the attenuated radiation that has passed through the object. The resulting

radiation data generated by the radiation detector assembly 103 is processed by the processing unit 109 together with first calibration data 111 describing properties of the first detector array 105 and second calibration data 112 describing properties of the second detector array 106 to generate

5 tomographic images of the object. Consequently, by using first and second calibration data 111 112 there may be compensated for a misalignment between the first detector array 105 and the second detector array 106 and / or a rotation of the first detector array 105 or the second detector array 106. The support 107 may optionally comprise a reference object 113-116. In this

10 embodiment, the reference object comprises four spatial markers 113-116. The processing unit 109 may be configured to obtain / generate the first calibration data 111 and the second calibration data 112 by processing radiation data received from the radiation detector assembly 103 originating from scanning the reference object 113-116. This may be done by examining

15 how the 'shadows' of the individual spatial markers 113-116 'propagates' over the detector arrays 105 106 when the support 107 is rotated.

The CT system 100 may be configured to scan the reference object 113-116 and the object 101 at the same time e.g. the processing unit 109 may be

20 configured to firstly generate the first calibration data 111 and the second calibration data 112 by processing first radiation data received from the radiation detector assembly 103, and secondly generate tomographic images of the object by processing the same first radiation data again but this time together with the newly generated first calibration data 111 and the second

25 calibration data 112. This may improve the speed as there is no need for a separate calibration step, and furthermore secure that the first calibration data 111 and the second calibration data 112 is completely updated thereby improving the precision. The memory unit 110 may be configured to store un-

30 processed radiation data generated by the radiation detector assembly 103 until the processing unit has generated the first calibration data 111 and the second calibration data 112.

Fig. 2a shows a schematic drawing of a radiation detector assembly 203 according to an embodiment of the present invention. The radiation detector assembly 203 is shown from the front. The radiation detector assembly 203
5 comprises a support 204, a first detector array 205 and a second detector array 206 both attached to the support 204. The first detector array 205 and the second detector array 206 are in this embodiment adhered to the support 204.

10 Fig. 2b shows a schematic drawing of a radiation detector assembly 203 according to an embodiment of the present invention. The radiation detector assembly 203 is shown from the front. The radiation detector assembly comprises a support 204, a first detector array 205 and a second detector array 206 both attached to the support 204. The support 204 comprises two
15 fixtures, a first fixture configured to grip the first detector array 205 and attach the first detector array 205 to the support 204 and a second fixture configured to grip the second detector array 206 and attach the second detector array 206 to the support 204.

20 Fig. 3 shows a schematic drawing of a radiation detector assembly 303 according to an embodiment of the present invention. The radiation detector assembly 303 is shown from the front. The radiation detector assembly 303 comprises a support 304, a first detector array 305, a second detector array 306, a third detector array 320, and a fourth detector array 321 all attached to
25 the support 304. The four detector arrays 305 306 320 321 are arranged in a 2x2 matrix. Fig. 3 further illustrates how the individual detector arrays may be slightly rotated and or displaced.

Fig. 4 shows a schematic drawing of a radiation detector assembly 403
30 according to an embodiment of the present invention. The radiation detector

assembly 403 is shown from the front. The radiation detector assembly 403 comprises a support and sixteen detector arrays arranged in an 4x4 matrix.

Fig. 5 shows a flow chart for a method for performing measurements on an
5 object using a CT system according to an embodiment of the present invention. The CT system may be a CT system similar to the CT system disclosed in relation to Fig. 1, i.e. the CT system may comprise: a support element for supporting the object; a radiation source for radiating the object; a radiation detector assembly for detecting radiation passed through the
10 object; and a processing unit operatively connected to the radiation detector assembly. The radiation detector assembly comprises a support, a first detector array, and a second detector array, the first detector array and the second detector array being attached to the support. The method start in step 101 with arranging the object at a plurality of angles with respect to the
15 radiation source and the radiation detector assembly and radiating the object at each of the plurality of angles using the radiation source thereby generating radiation data using the radiation detector assembly. Next, in step 102, tomographic images of the object is generated by processing, using the processing unit, the radiation data together with first calibration data
20 describing properties of the first detector array and second calibration data describing properties of the second detector array. Finally, in step 103 parts of the object are measured by analyzing the generated tomographic images.

Although some embodiments have been described and shown in detail, the
25 invention is not restricted to them, but may also be embodied in other ways within the scope of the subject matter defined in the following claims. In particular, it is to be understood that other embodiments may be utilised and structural and functional modifications may be made without departing from the scope of the present invention.

In device claims enumerating several means, several of these means can be embodied by one and the same item of hardware. The mere fact that certain measures are recited in mutually different dependent claims or described in different embodiments does not indicate that a combination of these measures
5 cannot be used to advantage.

It should be emphasized that the term "comprises/comprising" when used in this specification is taken to specify the presence of stated features, integers, steps or components but does not preclude the presence or addition of one
10 or more other features, integers, steps, components or groups thereof.

Claims:

1. A CT system for performing spatial measurements on an object comprising:

- 5
- a support element for supporting the object;
 - a radiation source for radiating the object at a plurality of different angles;
 - a radiation detector assembly for detecting radiation passed through the object and in response thereto generate radiation data; and
- 10
- a processing unit operatively connected to the radiation detector assembly;

wherein the radiation detector assembly comprises a support, a first detector array comprising a plurality of detector elements attached to a support, and a second detector array comprising a plurality of detector element attached to a support, the support of the first detector array being attached to the support of the radiation detector assembly, the support of the second detector array being attached to the support of the radiation detector assembly ; and said processing unit being configured to generate tomographic images of the object by processing radiation data received from the radiation detector assembly together with first calibration data describing properties of the first detector array and second calibration data describing properties of the second detector array.

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2. A CT system according to claim 1, wherein the first detector array is arranged immediately next to the second detector array, the plurality of detector elements of the first detector array and /or the second detector array are arranged with a pitch P, and wherein the smallest distance from the centre of any detector element of the first detector array to the centre of any detector element of the second detector array is at least 2 times larger than the pitch P, 5 times larger than the pitch P, or 10 times larger than the pitch P.

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3. A CT system according to claims 1 or 2, wherein the first detector array is arranged immediately next to the second detector array, and the smallest distance from the centre of any detector element of the first detector array to the centre of any detector element of the second detector array is at least 1mm, 0.5 cm, or 1cm.
4. A CT system according to any one of claims 1 to 3, wherein the first calibration data comprises data indicative of the spatial location the first detector array and the second calibration data comprises data indicative of the spatial location of the second detector array.
5. A CT system according to claim 3, wherein the first calibration data comprises data indicative of the orientation of the first detector array and the second calibration data comprises data indicative of the orientation of the second detector array.
6. A CT system according to any one claims 1 to 5, wherein the support element is rotatably arranged relative to the radiation sources and the radiation detector assembly.
7. A CT system according to any one of claims 1 to 6, wherein the processing unit is configured to obtain the first calibration data and the second calibration data by processing radiation data received from the radiation detector assembly originating from scanning a reference object.
8. A CT system according to claim 7, wherein the support element comprises the reference object.
9. A CT system according to any one of claims 6 to 8, wherein the processing unit is configured to firstly generate the first calibration data and the second

calibration data by processing first radiation data, and secondly generate tomographic images of the object by processing the first radiation data together with the first calibration data and the second calibration data.

5 10. A CT system according to any one of claim 6 to 9, wherein the processing unit is configured to firstly generate the first calibration data and the second calibration data by processing first radiation data, and secondly generate tomographic images of the object by processing the first radiation data together with the first calibration data and the second calibration data,
10 wherein the radiation data comprises data from a first set of different angles, the tomographic images consist of a plurality of pixels each pixel in a tomographic image is reconstructed using a reconstruction algorithm that utilizes data from a particular subset of the first set of different angles to take account of the spacing between the first detector array and the second
15 detector array, and wherein the processing unit it configured to for each pixel in the tomographic image determine the pixels particular subset from the first calibration data and the second calibration data.

11. A CT system according to claim 10, wherein the CT system is configured
20 to translate the object relative to the radiation source and radiation detector assembly between different angles.

12. A CT system according to any one of claims 1 to 11, wherein the radiation detector assembly is obtained by the process of:
25

- providing the support;
- providing the first detector array;
- providing the second detector array;
- attaching the support of the first detector array to the support of the radiation detector assembly;
- 30 • attaching the support of the second detector array to the support of the radiation detector assembly.

13. A method for performing spatial measurements on an object using a CT system, the CT system comprising: a support element for supporting the
5 object; a radiation source for radiating the object; a radiation detector assembly for detecting radiation passed through the object; and a processing unit operatively connected to the radiation detector assembly, wherein the radiation detector assembly comprises a support, a first detector array comprising a plurality of detector elements attached to a support, and a
10 second detector array comprising a plurality of detector element attached to a support, the support of the first detector array being attached to the support of the radiation detector assembly, the support of the second detector array being attached to the support of the radiation detector assembly, the method comprising the steps of:

- 15 • arranging the object at a plurality of angles with respect to the radiation source and the radiation detector assembly and radiating the object at each of the plurality of angles using the radiation source thereby generating radiation data using the radiation detector assembly;
- 20 • generating tomographic images of the object by processing using the processing unit, the radiation data together with first calibration data describing properties of the first detector array and second calibration data describing properties of the second detector array; and
- analyzing the tomographic images to measure parts of the object.

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14. Method a method according to claim 13, wherein the first calibration data comprises data indicative of the spatial location of the first detector array and the second calibration data comprises data indicative of the spatial location of the second detector array.

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15. A method according to claim 14, wherein the first calibration data comprises data indicative of the orientation of the first detector array and the second calibration data comprises data indicative of the orientation of the second detector array.

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16. A method according to any one claims 13 to 15, wherein the support element is rotatably arranged relative to the radiation source and the radiation detector assembly and the object is arranged at the plurality of angles by rotating it using the support element.

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17. A method according to any one of claims 13 to 16, wherein the processing unit is configured to obtain the first calibration data and the second calibration data by processing data from the radiation detector assembly originating from scanning a reference object.

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18. A method according to claim 17, wherein the support element comprises the reference object.

19. A method according to any one of claims 13 to 18, wherein the processing unit firstly generate the first calibration data and the second calibration data by processing the radiation data, and secondly generate tomographic images of the object by processing the radiation data together with the first calibration data and the second calibration data.

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20. A method according to any one of claims 13 to 19, wherein the processing unit firstly generate the first calibration data and the second calibration data by processing first radiation data, and secondly generate tomographic images of the object by processing the first radiation data together with the first calibration data and the second calibration data, wherein the radiation data comprises data from a first set of different angles, the tomographic images consist of a plurality of pixels each pixel in a

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tomographic image is reconstructed using a reconstruction algorithm that utilizes data from a particular subset of the first set of different angles to take account of the spacing between the first detector array and the second detector array, and wherein the processing unit is configured to for each pixel
5 in the tomographic image determine the pixels particular subset from the first calibration data and the second calibration data.

21. A method according to claim 20, wherein the object is translated relative to the radiation source and radiation detector assembly between different
10 angles.

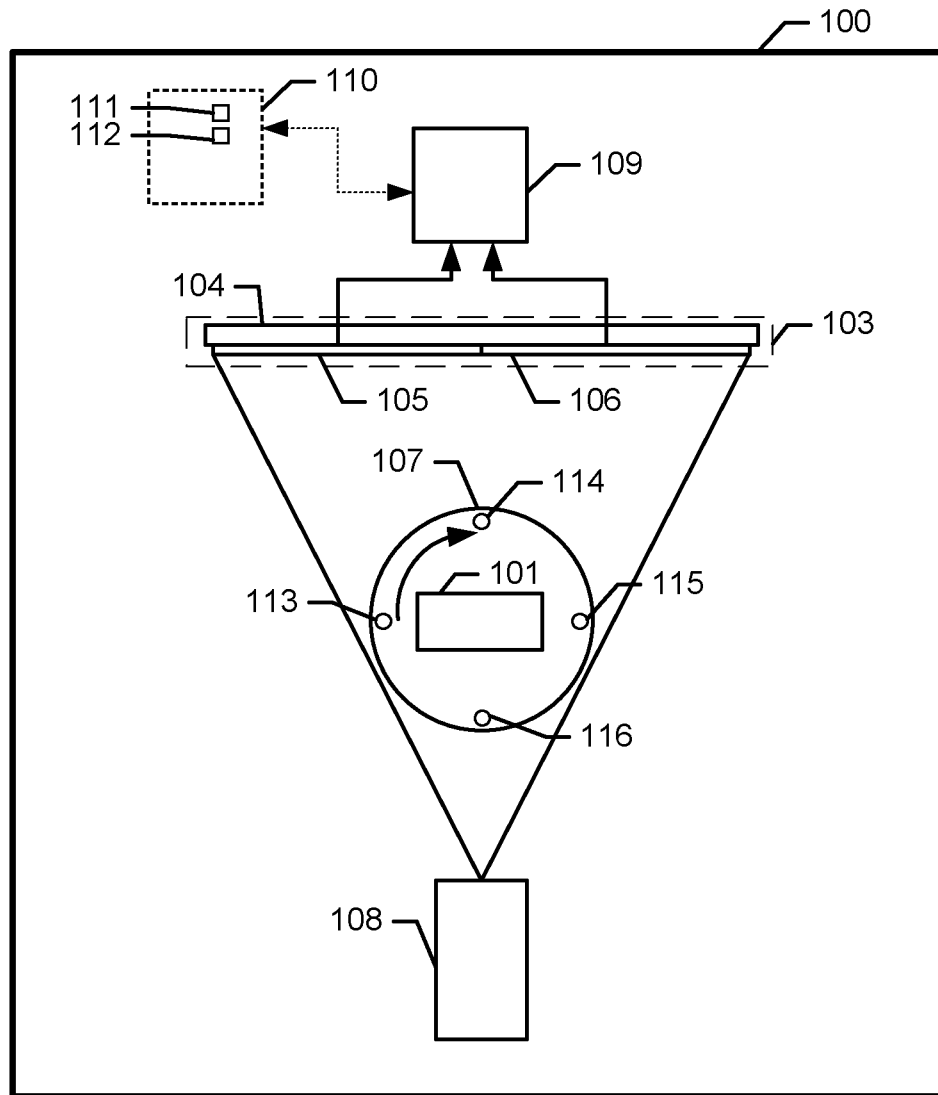


Fig. 1

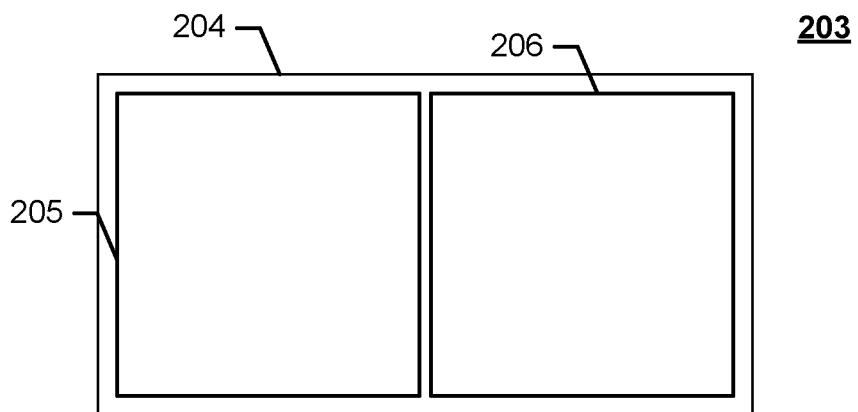


Fig. 2a

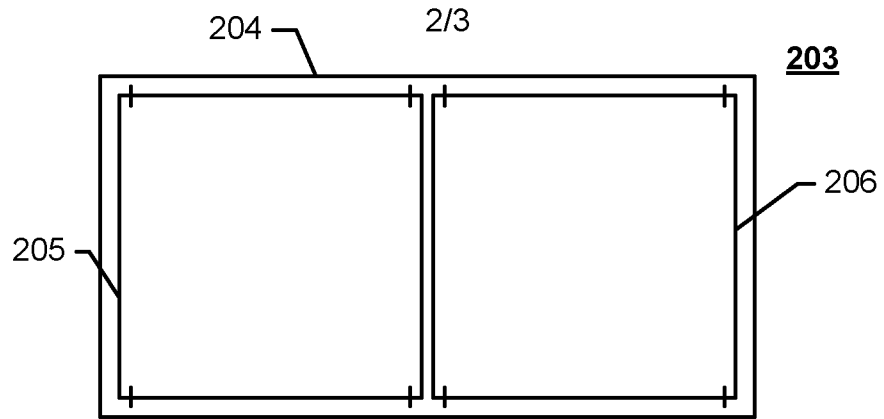


Fig. 2b

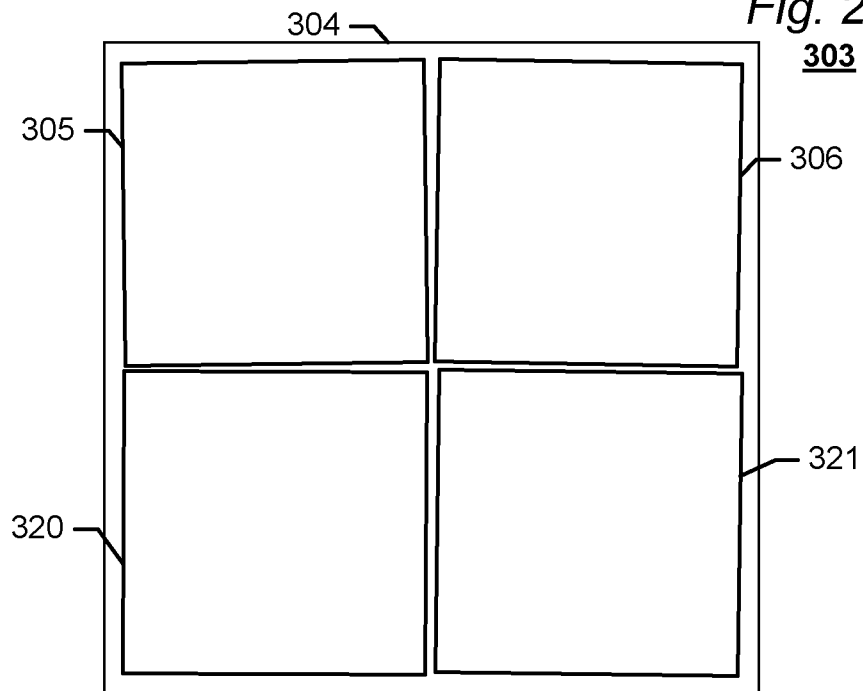


Fig. 3

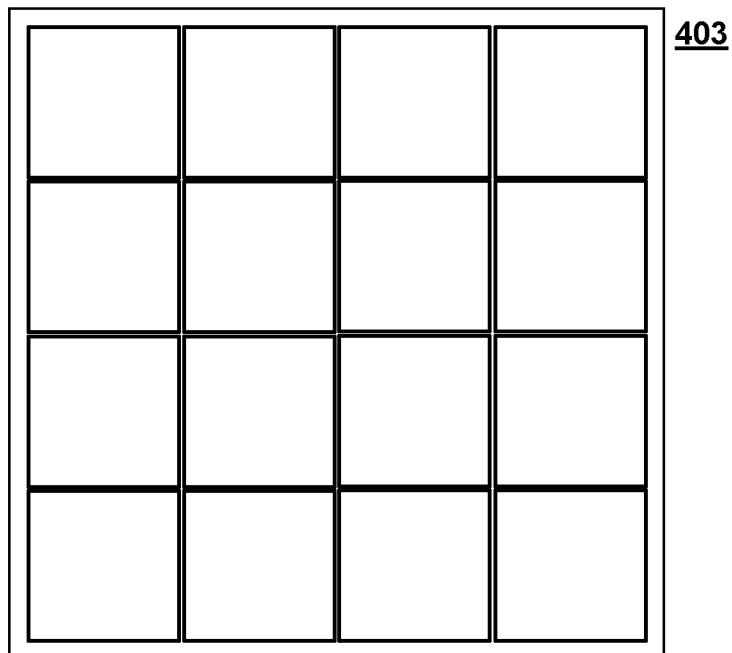


Fig. 4

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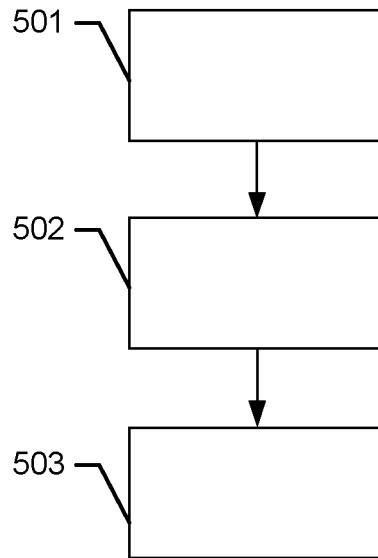


Fig. 5

INTERNATIONAL SEARCH REPORT

International application No
PCT/EP2017/059954

A. CLASSIFICATION OF SUBJECT MATTER
INV. G01N23/04
ADD.

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED
Minimum documentation searched (classification system followed by classification symbols)
G01N G01V

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)
EPO-Internal, WPI Data

C. DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	DE 10 2014 116595 A1 (WERTH MESSTECHNIK GMBH [DE]) 21 May 2015 (2015-05-21) paragraphs [0011] - [0013] paragraphs [0040], [0041]; figures 1, 2 -----	1-21
A	US 4 613 754 A (VINEGAR HAROLD J [US] ET AL) 23 September 1986 (1986-09-23) column 1, lines 23-46 -----	9,19
A	US 7 453 978 B1 (DIBIANCA FRANK A [US] ET AL) 18 November 2008 (2008-11-18) column 3, line 38 - column 4, line 31; figures 1, 2 column 6, lines 15-36; figure 9 ----- -/--	1-21

Further documents are listed in the continuation of Box C.

See patent family annex.

* Special categories of cited documents :

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- "O" document referring to an oral disclosure, use, exhibition or other means
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Date of the actual completion of the international search 15 May 2017	Date of mailing of the international search report 19/05/2017
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Name and mailing address of the ISA/ European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk Tel. (+31-70) 340-2040, Fax: (+31-70) 340-3016	Authorized officer Marzocchi, Olaf
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INTERNATIONAL SEARCH REPORT

International application No
PCT/EP2017/059954

C(Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	US 4 969 110 A (LITTLE FRANCIS H [US] ET AL) 6 November 1990 (1990-11-06) column 3, lines 25-41; figure 1 column 3, line 58 - column 4, line 22 -----	1-21
A	DE 10 2012 217759 A1 (SIEMENS AG [DE]) 3 April 2014 (2014-04-03) paragraph [0008] paragraphs [0026], [0027]; figure 1 paragraphs [0030], [0031]; figures 4-8 paragraph [0034] -----	1-21
A	WO 2004/096050 A1 (CXR LTD [GB]; MORTON EDWARD JAMES [GB]) 11 November 2004 (2004-11-11) page 2, lines 1-13 -----	1-21
A	WO 2015/053787 A1 (ANALOGIC CORP [US]) 16 April 2015 (2015-04-16) paragraphs [0056], [0058] -----	1-21

INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No PCT/EP2017/059954

Patent document cited in search report	Publication date	Patent family member(s)	Publication date
DE 102014116595 A1	21-05-2015	NONE	

US 4613754	A	23-09-1986	NONE

US 7453978	B1	18-11-2008	NONE

US 4969110	A	06-11-1990	CA 1309514 C 27-10-1992
		DE 3924066 A1	08-02-1990
		FR 2634923 A1	02-02-1990
		GB 2222356 A	28-02-1990
		IT 1231291 B	28-11-1991
		JP H0288951 A	29-03-1990
		US 4969110 A	06-11-1990

DE 102012217759 A1	03-04-2014	CN 103705267 A	09-04-2014
		DE 102012217759 A1	03-04-2014
		US 2014126688 A1	08-05-2014

WO 2004096050	A1	11-11-2004	AT 530118 T 15-11-2011
		CN 1780585 A	31-05-2006
		CN 101569531 A	04-11-2009
		EP 1617764 A1	25-01-2006
		EP 2002789 A1	17-12-2008
		GB 2415589 A	28-12-2005
		JP 4377406 B2	02-12-2009
		JP 4996647 B2	08-08-2012
		JP 2006524529 A	02-11-2006
		JP 2009183742 A	20-08-2009
		US 2007172024 A1	26-07-2007
		US 2010195788 A1	05-08-2010
		WO 2004096050 A1	11-11-2004

WO 2015053787	A1	16-04-2015	CN 105612433 A 25-05-2016
		EP 3055717 A1	17-08-2016
		US 2016231452 A1	11-08-2016
		WO 2015053787 A1	16-04-2015
